





SPECIFICATIONS					
ITEM	TEST METHOD	REQUIREMENTS	QT	AT	
DRY HEAT	EXPOSED AT $85\pm 2^{\circ}\text{C}$ , 96h.	① CONTACT RESISTANCE: $100\text{m}\Omega$ MAX. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	×	—	
COLD	EXPOSED AT $-55\pm 3^{\circ}\text{C}$ , 96h.		×	—	
SULPHUR DIOXIDE [JIS C 0090]	EXPOSED AT $40\pm 2^{\circ}\text{C}$ , RELATIVE HUMIDITY $80\pm 5\%$ , $25\pm 5$ ppm FOR 96h.	① CONTACT RESISTANCE: $100\text{m}\Omega$ MAX. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	×	—	
HYDROGEN SULPHIDE [JIS C 0092]	EXPOSED AT $40\pm 2^{\circ}\text{C}$ , RELATIVE HUMIDITY $80\pm 5\%$ , 10 TO 15 ppm FOR 96h.	③ NO EVIDENCE OF CORROSION WHICH AFFECTS TO OPERATION OF CONNECTOR.	×	—	
SOLDERABILITY	SOLDERED AT SOLDER TEMPERATURE, $235\pm 5^{\circ}\text{C}$ FOR IMMERSION DURATION, $2\pm 0.5$ sec.	A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	×	—	
RESISTANCE TO SOLDERING HEAT	1) REFLOW SOLDERING: PEAK TMP. $250^{\circ}\text{C}$ MAX. REFLOW TMP. $230^{\circ}\text{C}$ MIN WITHIN 60 sec. 2) SOLDERING IRONS: TMP. $350\pm 10^{\circ}\text{C}$ FOR $5\pm 1$ sec.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.	×	—	
<p><b>(note1)</b></p> <p>FASTEN FPC ON PCB OR SOMETHING FIXED IF FORCE IN VERTICAL DIRECTION SHALL BE PREDICTED. DO NOT CLOSE THE ACTUATOR BEFORE INSERTING FPC EVEN AFTER THE CONNECTOR IS MOUNTED ONTO A PCB. CLOSING THE ACTUATOR WITHOUT FPC COULD MAKE THE CONTACT GAP SMALLER, WHICH INCREASES THE FPC INSERTION FORCE. THIS CONNECTOR HAS CONTACT POINTS ON BOTH TOP AND BOTTOM.</p>					
Note QT:Qualification Test AT:Assurance Test X:Applicable Test		DRAWING NO.	ELC4-338903-01		
	SPECIFICATION SHEET		PART NO.	FH35C-**S-0.3SHW(50)	
	HIROSE ELECTRIC CO., LTD.		CODE NO.	CL580	 2/2